

DATA SHEET

SKY65227-11: WLAN 802.11n Single Band 2.4 GHz MIMO InterTM Front-End Module

Features

- Two full 2.4 GHz transmit/receive chains
- PCIe, miniPCI, Cardbus and Access Point applications
- Backward-compatible with 802.11b/g standards
- Pin compatible with SKY65225-11 (2.4 GHz)
- P_{OUT} @ 2.5% EVM: 19 dBm (-11b); 19 dBm (-11g)
- Gain matching: < 1.0 dB
- Internal voltage regulation
- Single 3.0–3.6 V power supply
- Temperature-compensated PA bias networks and directional power detection
- Separate digital controls for each PA
- Package size: 10 x 14 x 0.9 mm
- Lead (Pb)-free and RoHS-compliant MSL-3 @ 250 °C per JEDEC J-STD-020

NEW

Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.



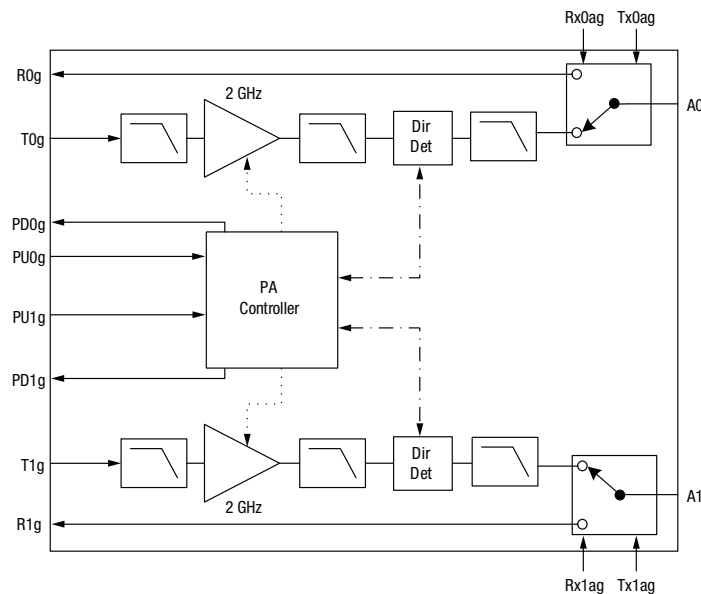
Description

The SKY65227-11 InterⁿFEM contains two complete 2.4 GHz transmit/receive chains in one compact RF front-end module optimized for single band 2.4 GHz MIMO (multiple in—multiple out) operation, in compliance with the 802.11n draft standard. The SKY65227-11 includes two 2 GHz PAs with integrated input filtering for 3–4 GHz rejection, and temperature-compensated, directional power detector with 20 dB dynamic range. Also included are low loss, high rejection GaAs harmonic filters and T/R switches which provide high linearity in all transmit paths and low loss in all receive paths.

The SKY65227-11 InterⁿFEM achieves outstanding gain matching which is a critical requirement for MIMO operation. This is accomplished through mirrored layout symmetry.

The SKY65227-11 is packaged in a lead (Pb)-free, RoHS-compliant laminate package, which measures 140 mm². This FEM is designed as a pin to pin compatible version of the SKY65225-11 for 2.4 GHz only.

Functional Block Diagram



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Absolute Maximum Ratings

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V _{CC}	V _{CC}		-0.3		5.5	V
PU0g, PU1g	PU		-0.3		5.5	V
T0g, T1g	RFin				10	dBm
Operating temperature range	T _{OP}		0		85	°C
Storage temperature range	T _{STO}		-65		125	°C
Moisture sensitivity level	MSL-3				250	°C
Thermal resistance	θ _{JC}				55	°C/W

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

Recommended Operating Conditions

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage	V _{CC}		3	3.3	3.6	V
Operating Temperature	T _{OP}		0	25	85	°C

DC Characteristics

Conditions: V_{CC} = 3.3 V, T_{OP} = 25 °C. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Total 802.11g Tx supply current, T0g or T1g	I _{CC-g}	P _{OUT} = 18 dBm, 54 Mbps OFDM, PU0g or PU1g = 3.3 V PU0a or PU1a = 0 V		190		mA
Total 802.11g Tx quiescent current, T0g or T1g	I _{CC-g}	No RF		95		mA
Total 802.11b Tx supply current, T0g or T1g	I _{CC-b}	P _{OUT} = 18 dBm, 11 Mbps CCK PU0g or PU1g = 3.3 V PU0a or PU1a = 0 V		190		mA

PA Logic Characteristics

Conditions: V_{CC} = 3.3 V, T_{OP} = 25 °C. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic high voltage for PU0g, PU1g, (Tx On)			2		V _{CC}	V
Logic low voltage for PU0g, PU1g, (Tx Off)			0		0.5	V
Input current logic high voltage for PU0g, PU1g				100	200	μA
Input current logic low voltage for PU0g, PU1g				0.2		μA

Switch Characteristics

Conditions: $V_{CC} = 3.3\text{ V}$, $T_{OP} = 25\text{ }^{\circ}\text{C}$. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into $50\ \Omega$ unless otherwise specified.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Control voltage - ON state	V_{CTL_on}		3	3.3	3.6	V
Control voltage - OFF state	V_{CTL_off}		0		0.2	V
Control current - ON state	I_{CTL_on}	RF ON		10	75	μA
Control current - ON state	I_{CTL_on}	RF OFF		2	20	μA

Mode Control Voltage Table (V)

Mode	V_{CC}	PU0g	Rx0g	Tx0g	PU1g	Rx1G	Tx1g
Sleep	3.3	0	0	0	0	0	0
T0g - ANTO	3.3	3.3	0	3.3	0	0	0
R0g - ANTO	3.3	0	3.3	0	0	0	0
T1g - ANT1	3.3	0	0	0	3.3	0	3.3
R1g - ANT1	3.3	0	0	0	0	3.3	0
802.11n Operation							
T0g - ANTO & T1g - ANT1	3.3	3.3	0	3.3	3.3	0	3.3
R0g - ANTO & R1g - ANT1	0 or 3.3	0	3.3	0	0	3.3	0

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be employed at all times.

802.11b,g Transmit Specifications (Tx Chain 0, Tx Chain 1)

Conditions: $V_{CC} = 3.3\text{ V}$, $T_{OP} = 25\text{ }^\circ\text{C}$. PA enables and control voltages set according to Mode Control Voltage table. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into $50\ \Omega$ unless otherwise specified.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Frequency range	F		2.4		2.5	GHz
Linear output power - g	Plin_g	54 Mbps OFDM, 64 QAM, EVM = 2.5 %		19		dBm
Compliant output power - b	P _{OUT_b}	11 Mbps CCK		19		dBm
Backed off EVM	BEVM	54 Mbps OFDM, 64 QAM, P _{OUT} = 8 dBm		1.5		%
1 dB compression point	P _{1 dB}		22.5	25		dBm
Small signal gain	IS ₂₁ I			25		dB
Small signal gain variation over frequency band	Δ IS ₂₁ I			1	2.5	dB
Gain matching, T0g to A0 vs. T1g to A1	IS ₂₁ I - M	Compared frequency by frequency		1		dB
Gain, 3.2–3.3 GHz	IS ₂₁ I - 3.2			-2	3	dB
Harmonics	2f, 3f	P _{OUT} = 18 dBm, 1 Mbps, CCK, 802.11b		-50	-42	dBm/MHz
Tx switching time	t _{sw}	50 % of V _{CTL} to 90/10 % RF output			500	ns
Input return loss	IS ₁₁ I	T0g or T1g		-10		dB
Output return loss	IS ₂₂ I	A0 or A1		-8		dB
Isolation between T0g and A1	ISO-A1	CW power into T0g and measure ratio of power at A0 to A1			-25	dBc
Isolation between T1g and A0	ISO-A0	CW power into T1g and measure ratio of power at A1 to A0			-25	dBc
Stability	STAB	P _{OUT} ≤ 18 dBm, load VSWR = 3:1	All non-harmonically related outputs less than -50 dBc/1 MHz			

802.11b,g Receive Specifications (Rx Chain 0, Rx Chain 1)

Conditions: $V_{CC} = 3.3\text{ V}$, $T_{OP} = 25\text{ }^\circ\text{C}$. PA enables & Tx control voltages = 0 V. Rx0ag or Rx1ag = 3.3 V. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into $50\ \Omega$ unless otherwise specified.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Frequency range	F		2.4		2.5	GHz
Insertion loss	IS ₂₁ I			1.5	2.0	dB
Input/output	IS ₁₁ I, IS ₂₂ I	R0g or R1g, A0 or A1		-15		dB
Insertion loss delta	Δ IS ₂₁ I	A0 to R0g and A1 to R1g			0.5	dB
Ant. isolation	ANT_ISO	A0 to R0g and A1 to R1g		25		dB
TR isolation	TR_ISO	Transmit A0 or A1, measure R0g or R1g		24		dB

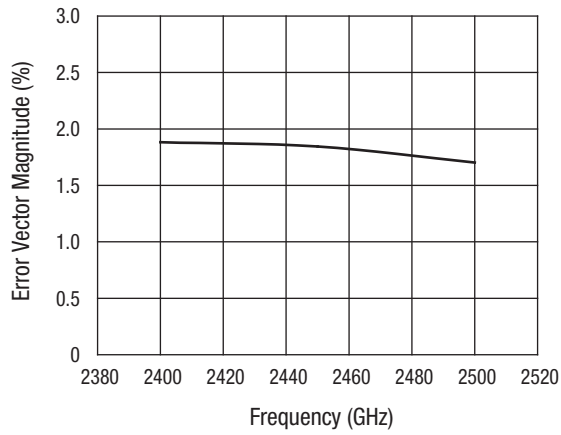
802.11b,g Power Detector Specification

Conditions: $V_{CC} = 3.3\text{ V}$, $T_{OP} = 25\text{ }^\circ\text{C}$. PU0g and Tx0ag or PU1g and Tx1ag = 3.3 V. RX0ag or RX1ag = 0 V. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into $50\ \Omega$ unless otherwise specified.

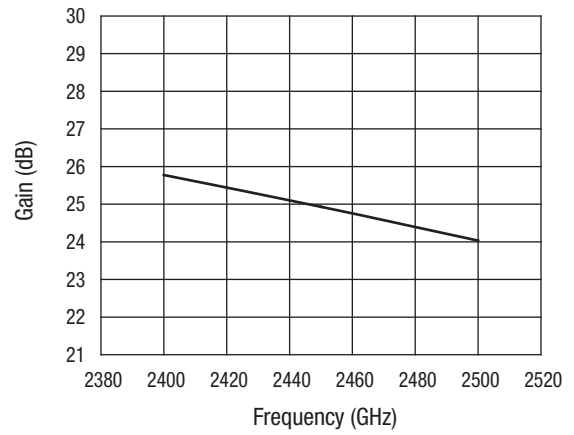
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Frequency range	F		2.4		2.5	GHz
Power detect range	PDR	A0 or A1	0		20	dBm
Power detector accuracy	PDacc2	Over 3:1 VSWR		1		dB
DC load impedance	Zload				3	k Ω
Output voltage, no RF			0.85		0.95	V
Output voltage, 20 dBm				0.35		V
Power detector -3 dB corner frequency	LPF-3 dB	10 k Ω load	270	300	400	kHz

Typical Performance Data (2.4–2.5 GHz)

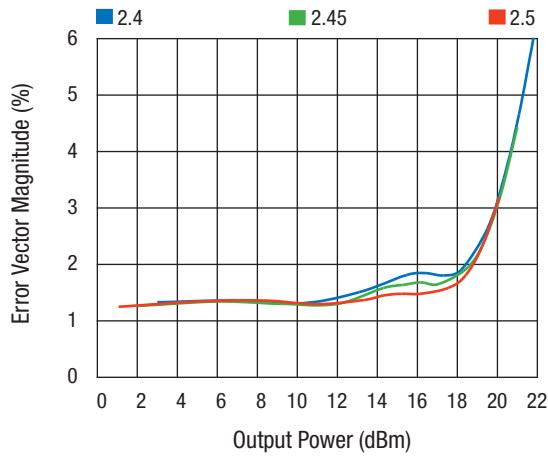
$V_{CC} = 3.3\text{ V}$, $T_A = 25\text{ }^\circ\text{C}$, OFDM 54 Mbps, $Z_0 = 50\text{ }\Omega$, unless otherwise noted



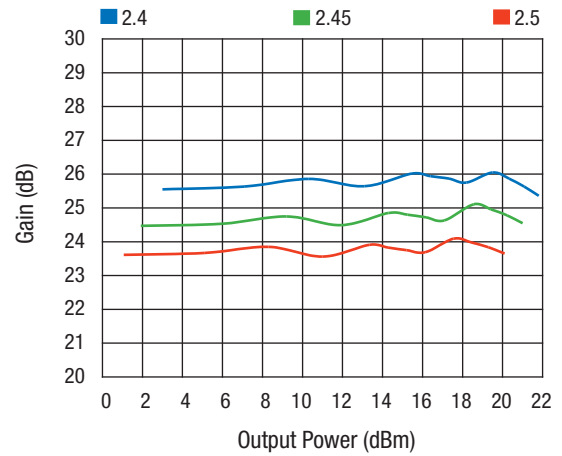
EVM vs. Frequency



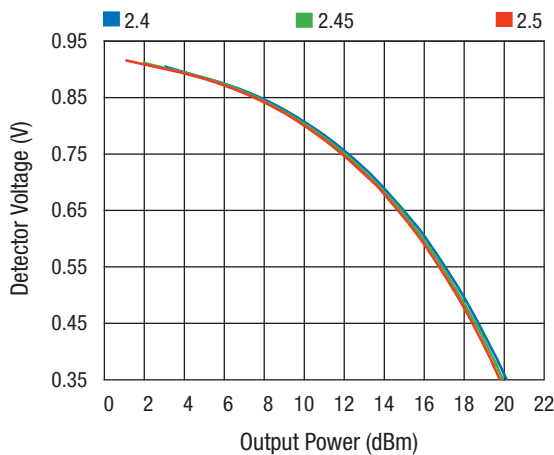
Gain vs. Frequency



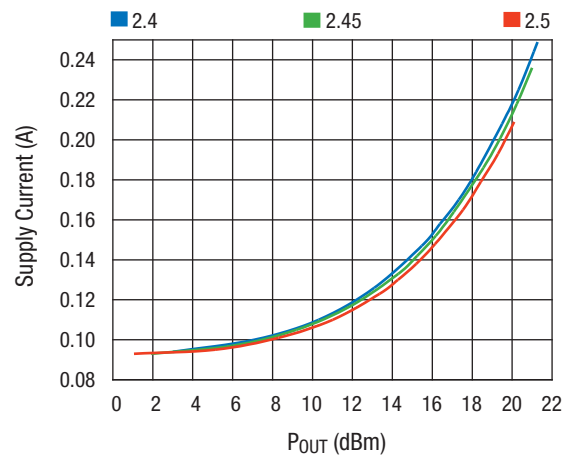
EVM vs. Output Power



Gain vs. Output Power

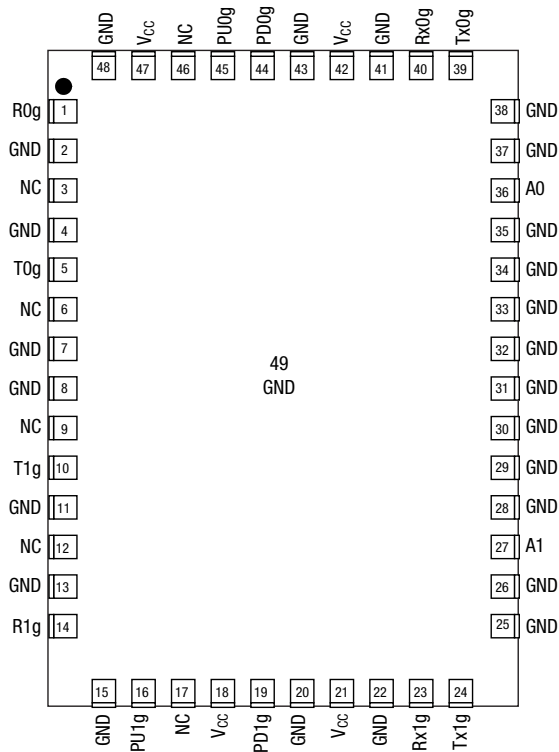


Detector Voltage vs. Output Power



Supply Current vs. Output Power

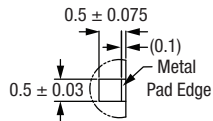
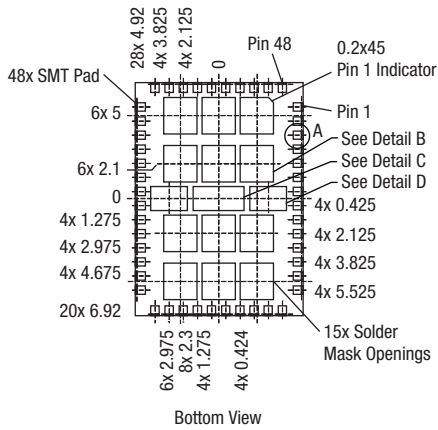
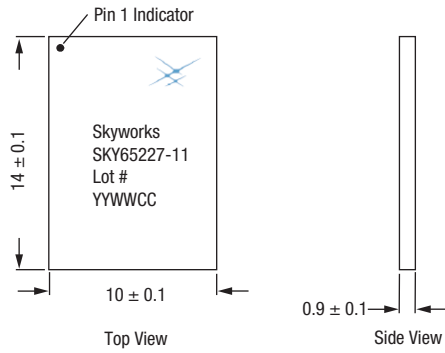
Pin Out



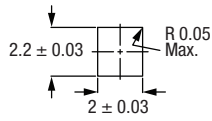
Pin Descriptions

Pin #	Pin Name	Description	EVB Label
1	ROg	Receiver output	ROg
2	GND	Ground	GND
3	NC	No connection	ROa
4	GND	Ground	GND
5	TOg	Transmitter input	TOg
6	NC	No connection	TOa
7	GND	Ground	GND
8	GND	Ground	GND
9	NC	No connection	T1a
10	T1g	Transmitter input	T1g
11	GND	Ground	GND
12	NC	No connection	R1a
13	GND	Ground	GND
14	R1g	Receiver output	R1g
15	GND	Ground	GND
16	PU1g	Power amplifier enable input	VEN1g
17	NC	No connection	VEN1a
18	V _{CC}	3.3 V	None. Tied to Pin 47
19	PD1g	Power detector output voltage from PA1	VD1ag
20	GND	Ground	GND
21	V _{CC}	3.3 V	None
22	GND	Ground	GND
23	RX1g	Switch control input	Rx1ag
24	TX1g	Switch control input	Tx1ag
25	GND	Ground	GND
26	GND	Ground	GND
27	A1	Antenna 1	A1
28	GND	Ground	GND
29	GND	Ground	GND
30	GND	Ground	GND
31	GND	Ground	GND
32	GND	Ground	GND
33	GND	Ground	GND
34	GND	Ground	GND
35	GND	Ground	GND
36	A0	Antenna 0	A0
37	GND	Ground	GND
38	GND	Ground	GND
39	Tx0g	Switch control input	TX0ag
40	Rx0g	Switch control input	RX0ag
41	GND	Ground	GND
42	V _{CC}	3.3 V	None
43	GND	Ground	GND
44	PD0g	Power detector output voltage from PA0	VDOag
45	PU0g	Power amplifier enable input	VEN0g
46	NC	No connection	VEN0a
47	V _{CC}	3.3 V	V _{CC}
48	GND	Ground	GND
49	GND	Ground	GND

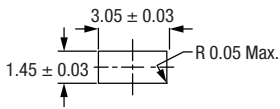
Package Outline



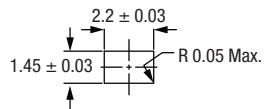
Detail A
Pad Scale: 2X
14X Rotated 180°
10X Rotated 90° CW
10X Rotated 90° CCW



Detail B
Scale: Full
12X

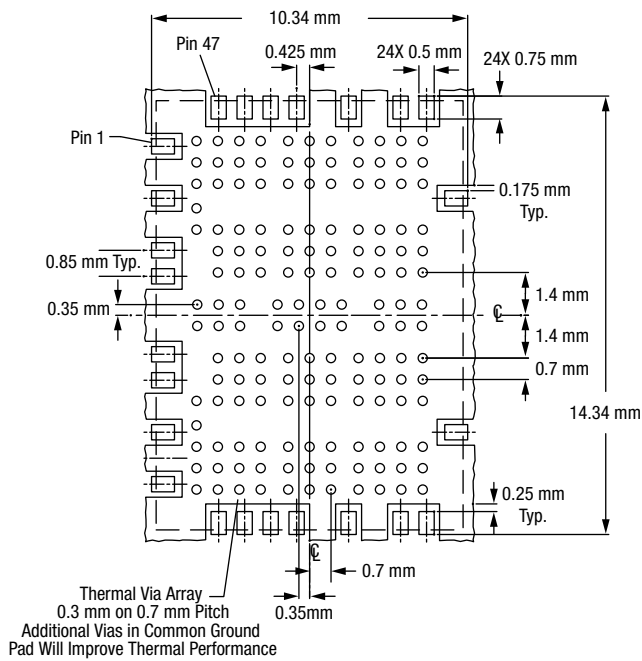


Detail C
Scale: Full



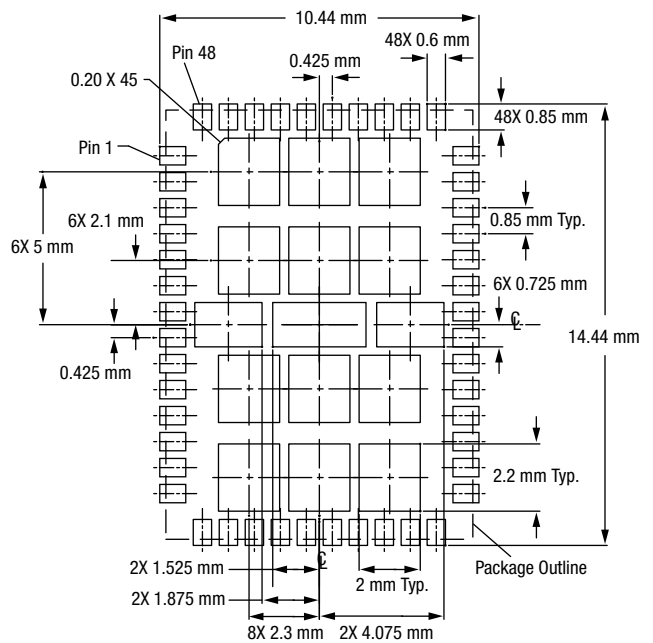
Detail D
Scale: Full
2X

Recommended Footprint

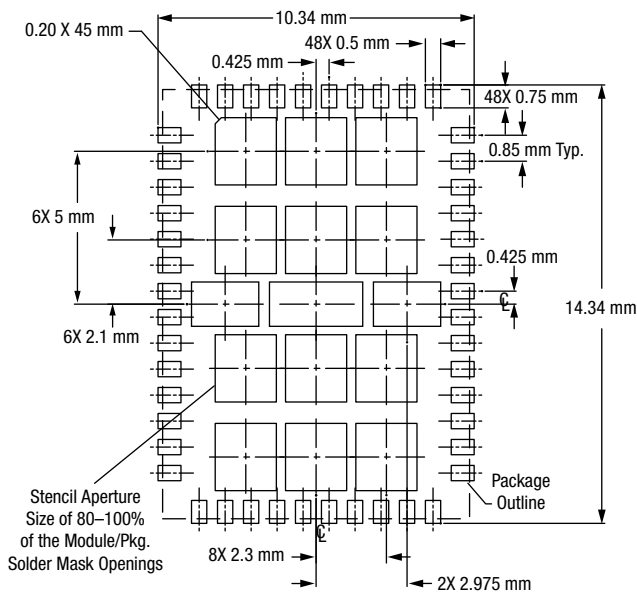


Thermal vias should be tented and filled with solder mask 30–35 µm copper plating recommended.

Solder Mask



Stencil Pattern



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